



TF0211

Single 1.9A High-Speed, Low-Side Gate Driver

Features

- Efficient, low-cost solution for driving MOSFETs and IGBTs
- Wide supply voltage operating range: 4.5V to 18V
- 1.9A source / 1.8A sink output current capability
- Non-inverting and inverting inputs (TF0211C)
- Non-inverting input with Enable pin (TF0211E)
- Fast propagation delays (35ns typical)
- Fast rise and fall times (15ns typical)
- Logic inputs (IN, IN*, and EN) 3.3V capability
- Space saving SOT23-5L package
- Extended temperature range: -40°C to +125°C

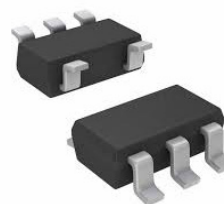
Applications

- Switch mode power supplies
- Line Drivers
- DC-DC Converters
- Motor Drive

Description

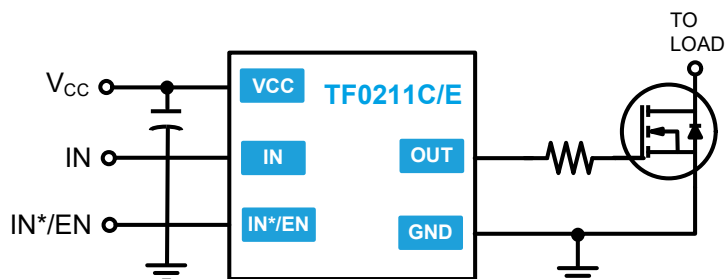
The TF0211 single high speed MOSFET and IGBT drivers are capable of driving 1.9A of peak current in low side driving configurations. The TF0211 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with MCUs. The TF0211C provides non-inverting and inverting inputs while the TF0211E provides a non-inverting input with an EN control.

Because of fast propagation times of 35ns typical and rise/fall times of 15ns typical the TF0211 is well suited for high speed applications like switch mode power supplies and PFC circuits. The TF0211 comes in a space-saving SOT23-5L package and it operates over an extended -40 °C to +125 °C temperature range.



SOT-23-5L

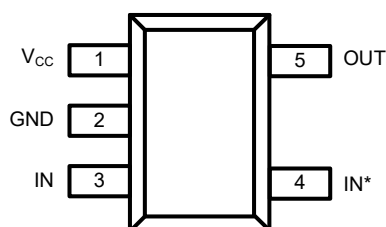
Typical Application



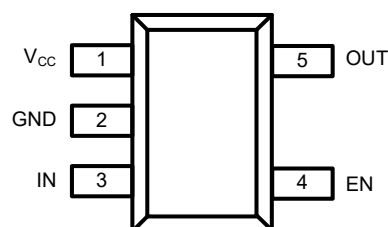


Pin Diagrams

Single 1.9A High-Speed, Low-Side Gate Driver



TF0211C



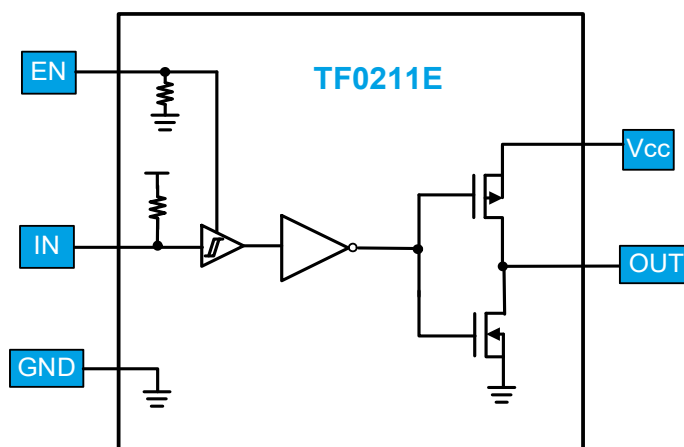
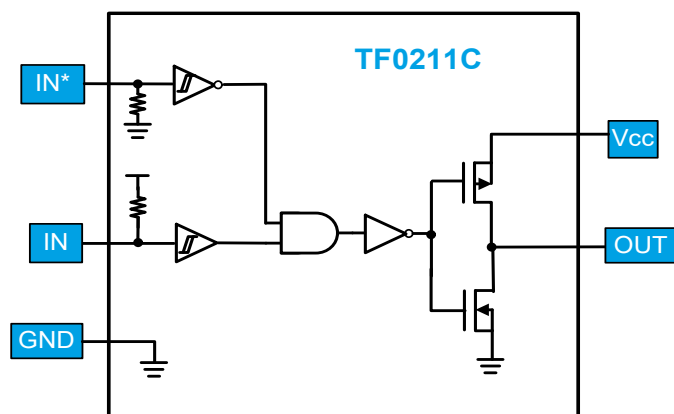
TF0211E

Top View: SOT23-5L

Pin Descriptions

| PIN NAME | PIN NUMBER | PIN DESCRIPTION |
|-----------------|------------|---|
| V _{CC} | 1 | Supply input |
| GND | 2 | Supply return |
| IN | 3 | Logic input, see input/output response table pg. 3 |
| IN* (TF0211C) | 4 | Logic input, see input/output response table pg. 3 |
| EN (TF0211E) | 4 | Enable input, see input/output response table pg. 3 |

Functional Block Diagram





Single 1.9A High-Speed, Low-Side Gate Driver

Absolute Maximum Ratings (NOTE1)

V_{CC} - Low-side fixed supply voltage.....-0.3V to +22V
 V_{OUT} - Output voltage (OUT).....-0.3V to $V_{CC} + 0.3V$
 V_{IN} - Logic input voltage (IN, IN*, EN).....-0.3V to $V_{CC} + 0.3V$

NOTE1 Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

P_D - Package power dissipation at $T_A \leq 25^\circ C$
 SOT23-5L.....TBD
 SOT23-5L Thermal Resistance (**NOTE2**)
 θ_{JA}TBD $^\circ C/W$
 θ_{JC}TBD $^\circ C/W$

T_J - Junction operating temperature.....+150 $^\circ C$
 T_L - Lead Temperature (soldering, 10 seconds).....+300 $^\circ C$
 T_{stg} - Storage temperature-55 to 150 $^\circ C$

NOTE2 When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

| Symbol | Parameter | MIN | MAX | Unit |
|-----------|-----------------------------------|-----|----------|------------|
| V_{CC} | Supply voltage | 4.5 | 18 | V |
| V_{OUT} | Output voltage (OUT) | 0 | V_{CC} | V |
| V_{IN} | Logic input voltage (IN, IN*, EN) | 0 | 5 | V |
| T_A | Ambient temperature | -40 | 125 | $^\circ C$ |

Input/Output response table

| IN | IN*(TF0211C)/ EN(TF0211E) | OUT (TF0211C) | OUT (TF0211E) |
|----|------------------------------|---------------|---------------|
| 0 | 0 | 0 | 1 |
| 0 | 1 | 0 | 0 |
| 1 | 0 | 1 | 1 |
| 1 | 1 | 0 | 1 |



Single 1.9A High-Speed, Low-Side Gate Driver

Electrical Characteristics (NOTE3)

$V_{CC} = 12V$, $T_A = 25^\circ C$, unless otherwise specified.

| Symbol | Parameter | Conditions | MIN | TYP | MAX | Unit |
|----------------------------------|---|-------------------------------------|-----|-----|-----|---------|
| DC Characteristics | | | | | | |
| V_{IH} | Logic "1" input voltage | | 2.4 | 1.6 | | V |
| V_{IL} | Logic "0" input voltage | | | 1.3 | 0.8 | |
| I_{IN+} | Logic "1" input bias current | $V_{IN} = 3V, V_{IN^*}/V_{EN} = 0V$ | | | 5 | μA |
| I_{IN-} | Logic "0" input bias current | $V_{IN} = 0V, V_{IN^*}/V_{EN} = 3V$ | | | 2 | |
| V_{OH} | High level output voltage, $V_{BIAS} - V_O$ | | | 25 | | mV |
| V_{OL} | Low level output voltage | | | 25 | | |
| I_{CCQ} | V_{CC} quiescent supply current | $V_{IN} = 0V$ or $3V$ | | 50 | 100 | μA |
| I_{O+} | Output high short circuit pulsed current | | | 1.9 | | A |
| I_{O-} | Output low short circuit pulsed current | | | 1.8 | | |
| I_{RVS} | Output reverse current withstand | | | 250 | | mA |
| Switching Characteristics | | | | | | |
| t_r | Turn-on rise time | $C_L = 1000pF$ | | 15 | 25 | ns |
| t_f | Turn-off fall time | $C_L = 1000pF$ | | 15 | 25 | ns |
| t_{on} | Turn-on propagation delay | | | 35 | 50 | ns |
| t_{off} | Turn-off propagation delay | | | 35 | 55 | ns |

NOTE3 The V_{IN} and I_{IN} parameters are applicable to the logic input pin: IN, IN*, and EN. The V_O and I_O parameters are applicable to the output pin: OUT.

Timing Waveforms

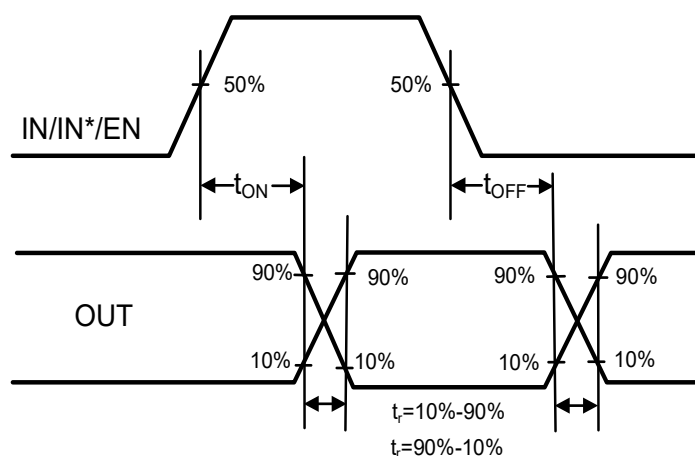


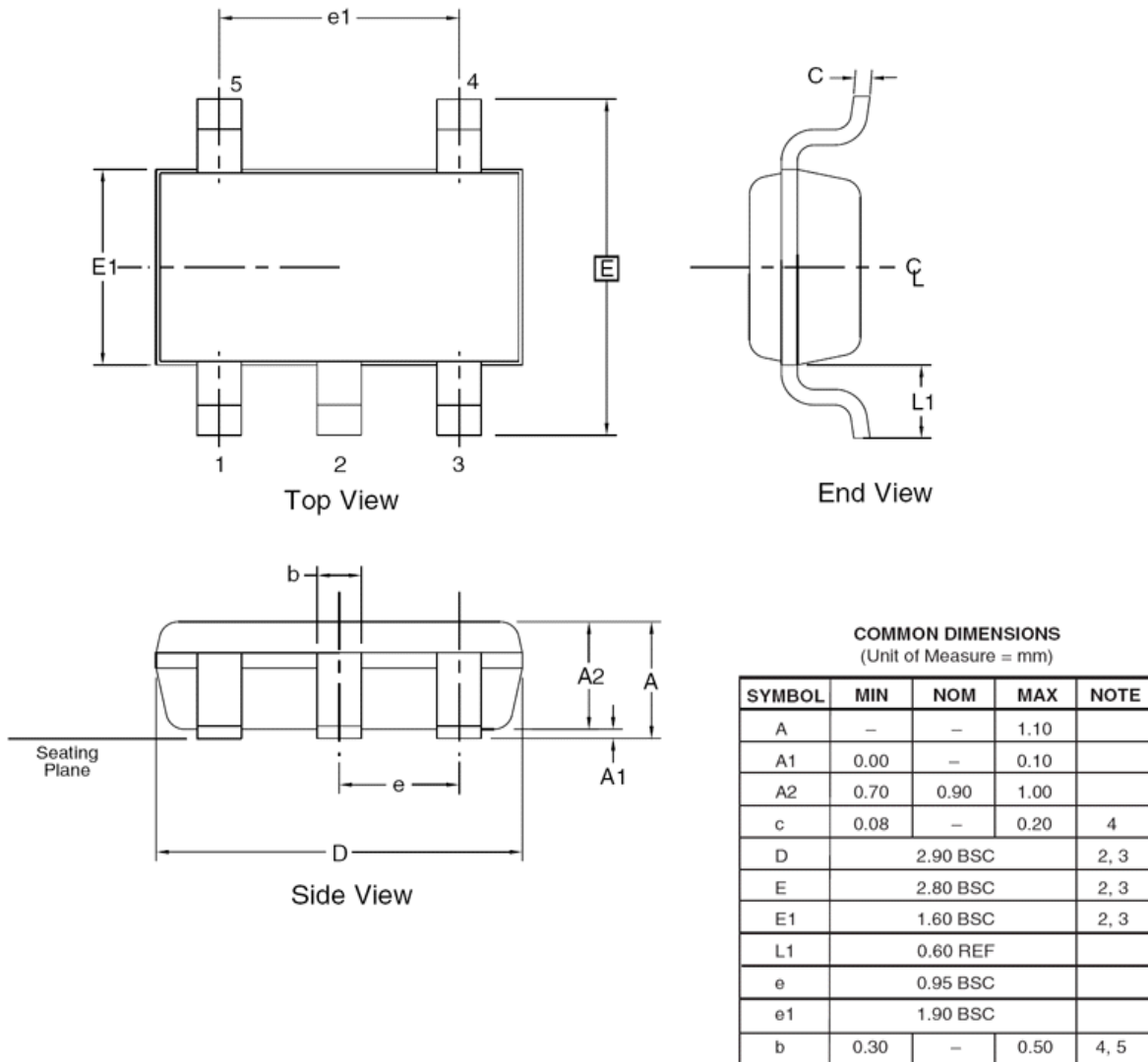
Figure 1. Switching Time Waveform Definitions



Package Dimensions (SOT23-5L)

Single 1.9A High-Speed, Low-Side Gate Driver

Please contact support@tfsemi.com for package availability.





Revision History

| Rev. | Change | Owner | Date |
|------|---------------|-----------------|-----------|
| 1.0 | First release | Keith Spaulding | 3/20/2019 |

Important Notice

TF Semiconductor Solutions (TFSS) PRODUCTS ARE NEITHER DESIGNED NOR INTENDED FOR USE IN MILITARY AND/OR AEROSPACE, AUTOMOTIVE OR MEDICAL DEVICES OR SYSTEMS UNLESS THE SPECIFIC TFSS PRODUCTS ARE SPECIFICALLY DESIGNATED BY TFSS FOR SUCH USE. BUYERS ACKNOWLEDGE AND AGREE THAT ANY SUCH USE OF TFSS PRODUCTS WHICH TFSS HAS NOT DESIGNATED FOR USE IN MILITARY AND/OR AEROSPACE, AUTOMOTIVE OR MEDICAL DEVICES OR SYSTEMS IS SOLELY AT THE BUYER'S RISK.

TFSS assumes no liability for application assistance or customer product design. Customers are responsible for their products and applications using TFSS products.

Resale of TFSS products or services with statements different from or beyond the parameters stated by TFSS for that product or service voids all express and any implied warranties for the associated TFSS product or service. TFSS is not responsible or liable for any such statements.

©2019 TFSS. All Rights Reserved. Information and data in this document are owned by TFSS wholly and may not be edited, reproduced, or redistributed in any way without the express written consent from TFSS.

For additional information please contact support@tfsemi.com or visit www.tfsemi.com.